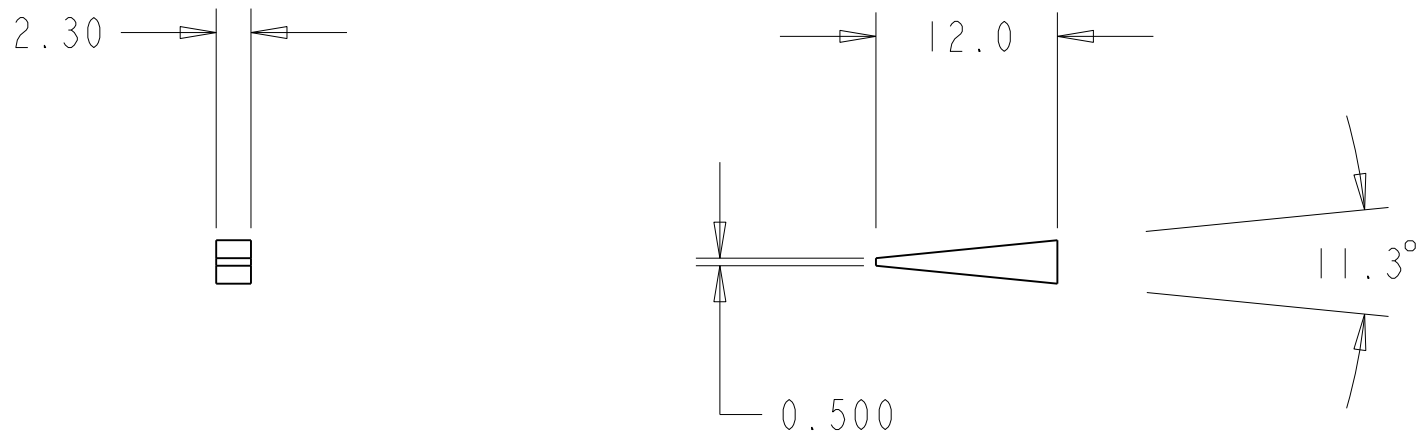




REV	DWG	CHK	DATE	CHANGES				DESCRIPTION				BFG 3D-CC	
UNLESS OTHERWISE SPECIFIED				SHOP ORDERS				ERNEST ORLANDO LAWRENCE BERKELEY NATIONAL LABORATORY UNIVERSITY OF CALIFORNIA - BERKELEY				MATERIAL	
TOLERANCES				ACCT NO. See J.O. NO. 120				SER NO. -				DO NOT SCALE PRINTS	
X.X ±0.1				FRAC. ±1/64				DATE ISSD -				SCALE: 2.000	
X.XX ±0.01				Angles ±0.50°				DATE RECD -				SHEET 1 OF 1	
X.XXX ±0.001				FINISH 125 μm				DATE RECD -				DWG. NO. 21F3591	
DO NOT SCALE PRINT				PROJECT NAME US ATLAS SILICON SUBSYSTEM				MICROFILMED: PART 21F406				SIZE 1	
THREADS ARE CLASS 2				PROJECT NUMBER ATL-IP-ED-0035				PATENT CLEAR: PIAP-11 AP6110				REV. 1	
CHAMFER ENDS OF ALL SCREW THREADS 30°				DWG BY D UKEN DATE 18-Feb-01				DESIGN ACCT. NO. 21F3591				DWG. NO. 21F3591	
CUT ROUND, 1.5 THREAD RELIEF ON MACHINED THREADS				CHK BY J WIRTH DATE 29-Jun-01				CATEGORY CODE				SIZE 1	
BREAK EDGES .016 MAX. ON MACHINED WORK				APR BY E ANDERSSSEN DATE				DWG. NO. 21F3591				REV. 1	
REMOVE BURRS, WELD SPLATTER & LOOSE SCALE													
IN ACCORDANCE WITH ASME Y14.5M & B46.1													